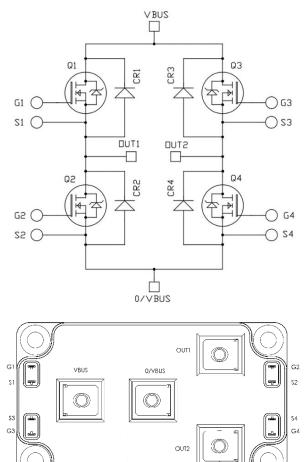


### Full Bridge SiC Power Module

#### **Product Overview**

The MSCSM120HM063CAG device is a 1200 V, 333 A full bridge silicon carbide (SiC) power module.



All ratings at  $T_J$  = 25 °C, unless otherwise specified.

Caution: These devices are sensitive to electrostatic discharge. Proper handling procedures must be followed.

#### Features

The following are key features of the MSCSM120HM063CAG device:

- SiC Schottky Diode
  - Zero reverse recovery
  - Zero forward recovery
  - Temperature independent switching behavior
  - Positive temperature coefficient on VF
- SiC Power MOSFET
  - Low R<sub>DS(on)</sub>
  - High temperature performance
  - Kelvin source for easy drive
- Low stray inductance
- M5 power connectors
- Aluminum nitride (AIN) substrate for improved thermal performance

#### Benefits

The following are benefits of the MSCSM120HM063CAG device:

- High efficiency converter
- Outstanding performance at high frequency operation
- Stable temperature behavior
- Direct mounting to heatsink (isolated package)
- Low junction-to-case thermal resistance
- RoHS compliant

#### Application

The MSCSM120HM063CAG device is designed for the following applications:

- Welding converters
- Switched mode power supplies
- Uninterruptible power supplies
- EV motor and traction drive

### 1. Electrical Specifications

This section provides the electrical specifications of the MSCSM120HM063CAG device.

#### 1.1 SiC MOSFET Characteristics

The following table lists the absolute maximum ratings per SiC MOSFET of the MSCSM120HM063CAG device.

Symbol	Parameter		Maximum Ratings	Unit
V <sub>DSS</sub>	Drain-Source vol	age	1200	V
I <sub>D</sub>	Continuous	T <sub>C</sub> = 25 °C	333	А
	drain current	T <sub>C</sub> = 80 °C	265	
I <sub>DM</sub>	Pulsed drain curr	ent	660	
V <sub>GS</sub>	Gate-Source volt	Gate-Source voltage		V
R <sub>DS(on)</sub>	Drain-Source ON resistance		7.8	mΩ
P <sub>D</sub>	Power dissipation	T <sub>C</sub> = 25 °C	873	W

Table 1-1. Absolute Maximum Ratings per SiC MOSFET

**Note:** 1. Specification of SiC MOSFET device but output current must be limited due to size of power connectors. The following table lists the electrical characteristics per SiC MOSFET of the MSCSM120HM063CAG device.

Table 1-2. Electrical Characteristics per SiC MOSFET

Symbol	Characteristics	Test Conditions		Min	Тур	Max	Unit
I <sub>DSS</sub>	Zero gate voltage drain current	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 1200 V -		_	40	400	μA
R <sub>DS(on)</sub>	Drain-Source	V <sub>GS</sub> = 20 V	T <sub>J</sub> = 25 °C	—	6.3	7.8	mΩ
	on resistance	I <sub>D</sub> = 80 A	T <sub>J</sub> = 175 °C	_	10	_	
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{GS} = V_{DS}, I_D = 4$	mA	1.8	2.8	—	V
I <sub>GSS</sub>	Gate–Source leakage current	V <sub>GS</sub> = 20 V, V <sub>DS</sub> =	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V		_	400	nA

**Electrical Specifications** 

The following table lists the dynamic characteristics per SiC MOSFET of the MSCSM120HM063CAG device.

Symbol	Characteristics	Test Conditions		Min	Тур	Max	Unit
C <sub>iss</sub>	Input capacitance	V <sub>GS</sub> = 0 V		—	12	—	nF
C <sub>oss</sub>	Output capacitance	V <sub>DS</sub> = 1000 V		—	1	—	
C <sub>rss</sub>	Reverse transfer capacitance	f = 1 MHz		_	0.1	_	
Qg	Total gate charge	$V_{GS}$ = -5 V/20 V		_	928	—	nC
Q <sub>gs</sub>	Gate-Source charge	V <sub>Bus</sub> = 800 V		—	164	—	
Q <sub>gd</sub>	Gate-Drain charge	I <sub>D</sub> = 160 A		_	200	—	
T <sub>d(on)</sub>	Turn-on delay time	V <sub>GS</sub> = -5 V/20 V V <sub>Bus</sub> = 600 V I <sub>D</sub> = 200 A; T <sub>J</sub> = 150 °C		_	60	—	ns
Tr	Rise time			—	50	—	
T <sub>d(off)</sub>	Turn-off delay time			—	180	—	
T <sub>f</sub>	Fall time	$R_{G(ON)} = 2 \Omega; R_{G(ON)}$	<sub>OFF)</sub> = 1.2 Ω	—	30	—	
Eon	Turn-on energy	V <sub>GS</sub> = -5/20 V	T <sub>J</sub> = 150 °C	_	4.1	—	mJ
E <sub>off</sub>	Turn-off energy	$V_{Bus}$ = 600 V $I_D$ = 200 A $R_{G(ON)}$ = 2 Ω $R_{G(OFF)}$ = 1.2 Ω	T <sub>J</sub> = 150 °C	-	3.6	—	mJ
R <sub>Gint</sub>	Internal gate resistanc	e		_	1.5	_	Ω
R <sub>thJC</sub>	Junction-to-case thern	nal resistance		—	—	0.11	°C/W

Table 1-3. Dynamic Characteristics per SiC MOSFET

The following table lists the body diode ratings and characteristics per SiC MOSFET of the MSCSM120HM063CAG device.

Table 1-4. Body Diode Ratings and Characteristics per SiC MOSFET

Symbol	Characteristics	Test Conditions	Min	Тур	Max	Unit
V <sub>SD</sub>	Diode forward	V <sub>GS</sub> = 0 V; I <sub>SD</sub> = 160 A	—	4	—	V
	voltage	$V_{GS}$ = -5 V; I <sub>SD</sub> = 160 A	—	4.2	—	
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 160 A	_	90	—	ns
0		V <sub>GS</sub> = -5 V		0000		0
Q <sub>rr</sub>	Reverse recovery charge	$V_{\rm R} = 800 \rm V$	_	2200	_	nC
Irr	Reverse recovery current	di <sub>F</sub> /dt = 4000 A/µs		54	_	A

#### **Electrical Specifications**

#### 1.2 SiC Schottky Diode Ratings and Characteristics

The following table lists the SiC diode ratings and characteristics per SiC diode of MSCSM120HM063CAG device.

Symbol	Characteristics	Test Conditions		Min	Тур	Max	Unit
V <sub>RRM</sub>	Peak repetitive reverse	e voltage		—	—	1200	V
I <sub>RRM</sub>	Reverse leakage	V <sub>R</sub> =1200 V	T <sub>J</sub> = 25 °C	—	40	800	μA
	current		T <sub>J</sub> = 175 °C	—	600	—	
I <sub>F</sub>	DC forward current	—	T <sub>C</sub> = 100 °C	—	120	—	A
V <sub>F</sub>	/ <sub>F</sub> Diode forward	I <sub>F</sub> = 120 A	T <sub>J</sub> = 25 °C	_	1.5	1.8	V
	voltage		T <sub>J</sub> = 175 °C	—	2.1	—	-
Q <sub>C</sub>	Total capacitive charge	V <sub>R</sub> = 600 V	_		520	_	nC
С	Total capacitance	f = 1 MHz, V <sub>R</sub>	e = 400 V	—	564	—	pF
		f = 1 MHz, V <sub>R</sub>	e = 800 V	_	420	_	
R <sub>thJC</sub>	Junction-to-case thern	nal resistance		_	—	0.26	°C/W

#### Table 1-5. SiC Schottky Diode Ratings and Characteristics

#### **1.3** Thermal and Package Characteristics

The following table lists the thermal and package characteristics of MSCSM120HM063CAG device.

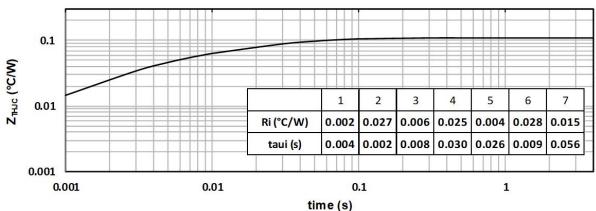
 Table 1-6.
 Thermal and Package Characteristics

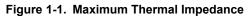
Symbol	Characteristics			Min	Мах	Unit
V <sub>ISOL</sub>	RMS isolation v	oltage, any termi	nal to case	4000	—	V
	t =1 min, 50 Hz/60 Hz					
TJ	Operating junction temperature range			-40	175	°C
T <sub>JOP</sub>		Recommended junction temperature under switching conditions			T <sub>Jmax</sub> –25	
T <sub>STG</sub>	Storage tempera	Storage temperature range			125	
T <sub>C</sub>	Operating case	temperature		-40	125	
Torque	Mounting	To heatsink	M6	3	5	N.m
	torque	For terminals	M5	2	3.5	
Wt	Package weight		_	300	g	

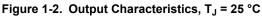
**Electrical Specifications** 

#### 1.4 **Typical SiC MOSFET Performance Curve**

This section shows the typical SiC MOSFET performance curves of the MSCSM120HM063CAG device.

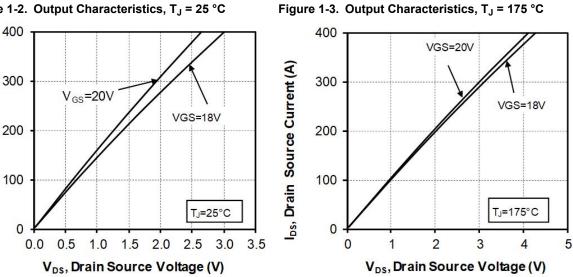




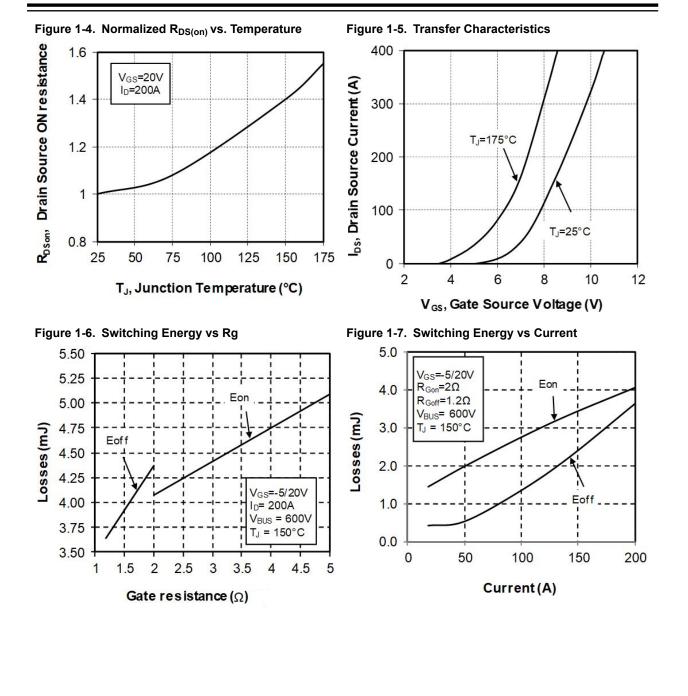


los, Drain Source Current (A)

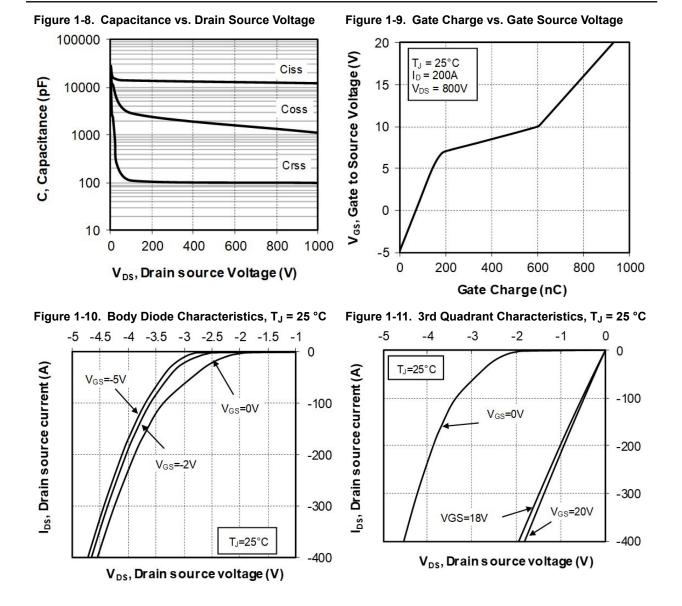




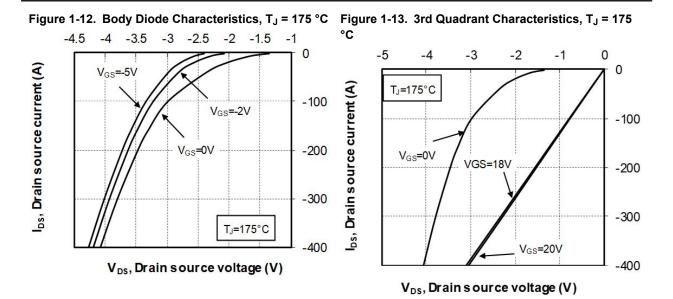
**Electrical Specifications** 

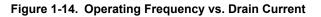


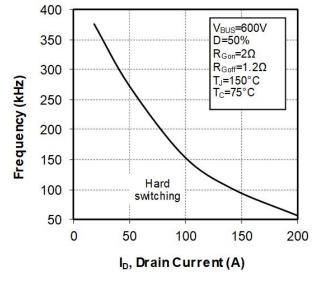
**Electrical Specifications** 



**Electrical Specifications** 







**Electrical Specifications** 

#### 1.5 Typical SiC Diode Performance Curve

This section shows the typical SiC diode performance curves of MSCSM120HM063CAG device.

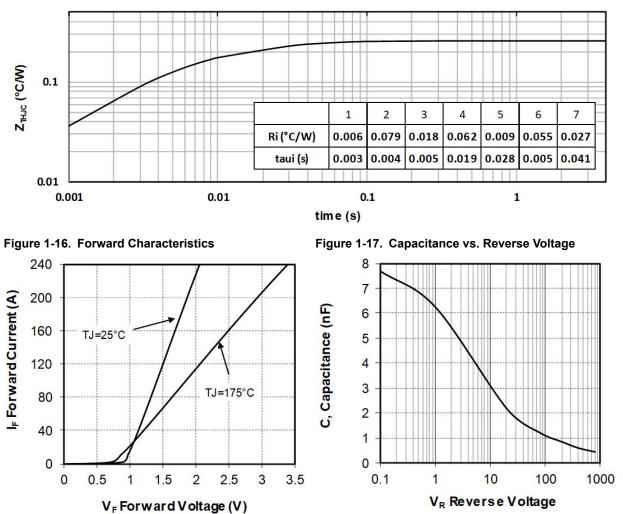


Figure 1-15. Maximum Thermal Impedance

#### Package Specifications

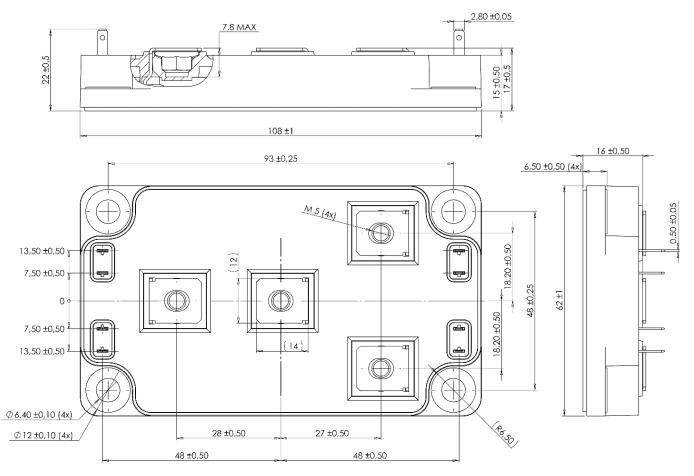
#### 2. Package Specifications

The following section shows the package specification of MSCSM120HM063CAG device.

#### 2.1 Package Outline

The following figure shows the package outline drawing of MSCSM120HM063CAG device. The dimensions are in millimeters.

#### Figure 2-1. Package Outline Drawing



Note: See Application Note APT0601—Mounting instructions for SP6 Power Modules for more information.

### 3. Revision History

Revision	Date	Description
Α	04/2021	This is the first publication of this document.

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